MULTI-LINE LOW CAPACITANCE TVS ARRAY



DESCRIPTION

The SMP6LCxx-2P Series are high powered multi-line low capacitance transient voltage suppressor arrays that provides board level protection for standard TTL and MOS bus line applications against the damaging effects of ESD, tertiary lightning and switching transients.

This series has a peak pulse power rating of 400 Watts for an $10/1000\mu s$ waveshape. This device series meets the IEC 61000-4-2, IEC 61000-4-4 and IEC 61000-4-5 requirements.

FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air 15kV, Contact 8kV
- Compatible with IEC 61000-4-4 (EFT): 40A 5/50ns
- Compatible with IEC 61000-4-5 (Surge): 100A (Applies to 5V)
- 100A (2/10µs) per Bellcore GR-1089 (Intra Building)
- 400 Watts Peak Pulse Power per Line (tp = 10/1000μs)
- 3,900 Watts Peak Pulse Power per Line (tp = 8/20μs)
- ITKU.20 I_{DD} @ 40A (5/310μs) (Applies to 5V and 6.5V)
- Bidirectional Configuration
- · High Surge Capability
- Available in Multiple Voltages
- Protects 2 Bidirectional Lines
- Low Capacitance < 30pF per Line Pair
- RoHS Compliant
- REACH Compliant

MECHANICAL CHARACTERISTICS

- Molded JEDEC SO-16 Package
- Approximate Weight: 0.15 grams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:

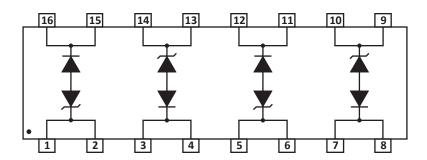
Pure-Tin - Sn, 100: 260-270°C

- 16mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0

APPLICATIONS

- T1/E1
- Customer Premise Equipment (CPE)
- Telecommunication Equipment
- Wireless Communication Equipment

PIN CONFIGURATION



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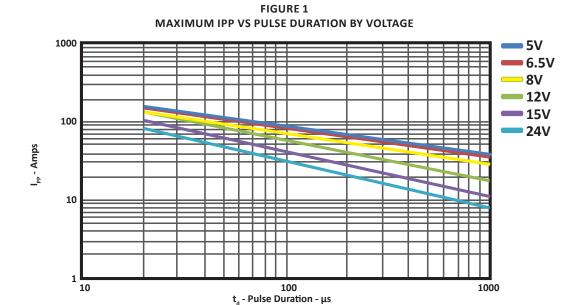
TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified								
PARAMETER SYMBOL VALUE								
Operating Temperature	T _L	-55 to 150	°C					
Storage Temperature	T _{stg}	-55 to 150	°C					
Peak Pulse Power (tp = 8/20μs) - See Figure 2	P _{pp}	3,900	Watts					
Peak Pulse Power (tp = 10/1000μs) - See Figure 2	P _{pp}	400	Watts					

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified									
PART NUMBER (Note 1)	RATED STAND-OFF VOLTAGE	MINIMUM BREAKDOWN VOLTAGE	MAXIMUM CLAMPING VOLTAGE (Fig. 3)	MAXIMUM LEAKAGE CURRENT	TYPICAL CAPACITANCE				
	V _{wm} VOLTS	@1mA V _(BR) VOLTS	@ 8/20μS V _c @ Ι _{թթ}	@V _{wм} Ι _D μΑ	@0V, 1MHz C pF				
SMP6LC05-2P	5.0	6.0	26.0V @ 150.0A	300	15				
SMP6LC6.5-2P	6.5	7.2	28.0V @ 150.0A	300	15				
SMP6LC08-2P	8.0	8.6	30.0V @ 145.0A	25	15				
SMP6LC12-2P	12.0	13.3	35.0V @ 140.0A	2	15				
SMP6LC15-2P	15.0	16.7	50.0V @ 110.0A	2	15				
SMP6LC24-2P	24.0	26.7	57.0V @ 80.0A	2	15				

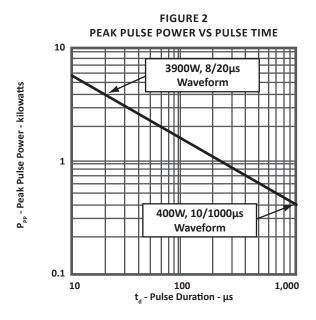
NOTES

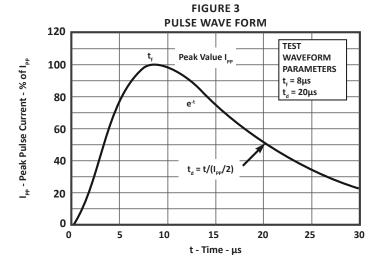
 $^{1. \ \ \, \}text{Do not surge from pins } 15/16 \ \text{to } 1/2, \ 3/4 \ \text{to } 13/14, \ 11/12 \ \text{to } 5/6 \ \text{and } 7/8 \ \text{to } 9/10. \ PIV \ \text{typically greater than } 100 \ \text{Volts for each rectifier diode.}$

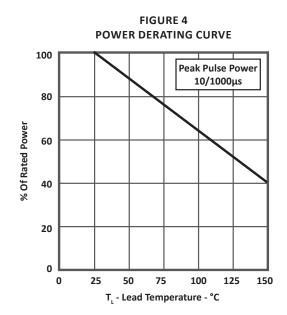


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TYPICAL DEVICE CHARACTERISTICS

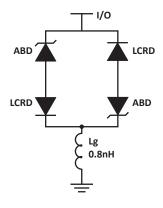






SPICE MODEL

FIGURE 1 SPICE MODEL



ABD - Avalanche Breakdown Diode (TVS) LCRD: Low Capacitance Rectifier Diode Lg - Lead Inductance

TABLE 1 - SPICE PARAMETERS							
PARAMETER	UNIT	ABD(TVS)	LCRD				
BV	V	See Table 2	200				
IBV	μΑ	1	0.01				
C _{jo}	pF	See Table 2	5				
I _s	Α	See Table 2	1E-13				
Vj	V	0.6	0.6				
М	-	0.33	0.33				
N	-	1	1				
R _s	Ohms	See Table 2	0.31				
TT	s	1E-8	1E-9				
EG	eV	1.11	1.11				

TABLE 2 - ABD SPECIFIC SPICE PARAMETERS								
PART NUMBER B _v (VOLTS) C _{io} (pF) I _s (AMPS) Rs(OH								
SMP6LC05-2P	6.0	3000	1E-11	0.075				
SMP6LC6.5-2P	7.2	2600	1E-11	0.075				
SMP6LC12-2P	13.3	1150	1E-13	0.080				

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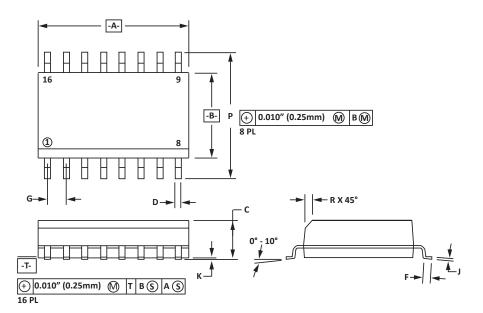


SO-16 PACKAGE INFORMATION

OUTLINE DIMENSIONS							
DIM	MILLIN	IETERS	INCHES				
ווועו	MIN	MAX	MIN	MAX			
А	9.80	10.00	0.386	0.393			
В	3.80	4.00	0.150	0.157			
С	1.35 1.75		0.054	0.068			
D	0.35	0.49	0.014	0.019			
F	0.40	1.25	0.016	0.049			
G	1.27	BSC	0.05	BSC			
J	0.18 0.25		0.007	0.009			
К	0.10 0.25		0.004	0.008			
Р	5.80	6.20	0.229	0.244			
R	0.25	0.50	0.010	0.019			

NOTES

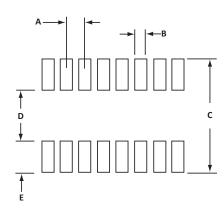
- 1. -T- = Seating plane and datum surface.
- 2. Dimensions "A" and "B" are datum.
- 3. Dimensions "A" and "B" do not include mold protrusion.
- 4. Maximum mold protrusion is 0.015" (0.380mm) per side.
- 5. Dimensioning and tolerances per ANSI Y14.5M, 1982.
- 6. Dimensions are exclusive of mold flash and metal burrs.



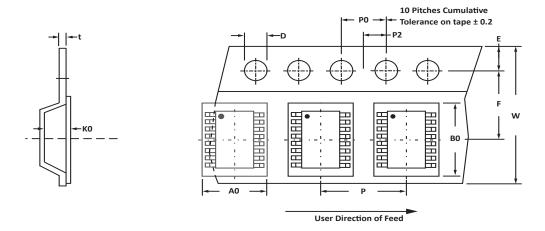
PAD LAYOUT DIMENSIONS								
DIM	MILLIN	METERS	INCHES					
DIM	MIN	MAX	MIN	MAX				
А	1.14	1.40	0.045	0.055				
В	0.64	0.89	0.025	0.035				
С	6.22	-	0.245	-				
D	3.94	4.17	0.155	0.165				
E	1.02	1.27	0.040	0.050				

NOTES

1. Controlling dimension: inches.



TAPE AND REEL



SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	Α0	В0	ко	D	E	F	w	P0	P2	Р	tmax
178mm (7")	16mm	6.50 ± 0.10	10.30 ± 0.10	2.10 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	16.00 ± 0.30	4.00 ± 0.12	2.00 ± 0.10	8.00 ± 0.10	0.25

NOTES

- 1. Dimensions are in millimeters.
- 2. Surface mount product is taped and reeled in accordance with EIA-481.
- 3. Suffix T7 = 7" Reel 1,000 pieces per 16mm tape.
- 4. Suffix T13 = 13" Reel 2,500 pieces per 16mm tape.
- 5. Bulk product shipped in tubes of 48 pieces per tube.
- 6. Marking on Part part number, date code, logo and pin one defined by dot on top of package.

ORDERING INFORMATION									
BASE PART NUMBER (xx = Voltage)	I IFADEREE SUEEIX I TAPE SUEEIX I OTY/REEI I REELSIZE I TU								
SMP6LCxx-2P	-LF	-T7	1,000	7"	48				
SMP6LCxx-2P	-LF	-T13	2,500	13"	48				
This device is only available in a Lead-Free configuration.									

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COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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